

/ Descriptions

TO-251 N MOS N-CHANNEL MOSFET in a TO-251 Plastic Package.

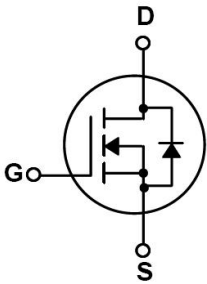
/ Features

Low gate charge, low crss, fast switching.

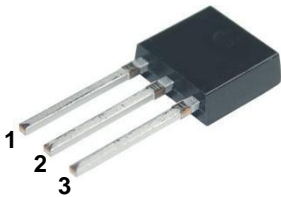
/ Applications

These devices are well suited for high efficiency switching DC/DC converters and switch mode power supplies.

/ Equivalent Circuit



/ Pinning



PIN1 G PIN 2 D PIN 3 S

/ h_{FE} Classifications & Marking

See Marking Instructions.

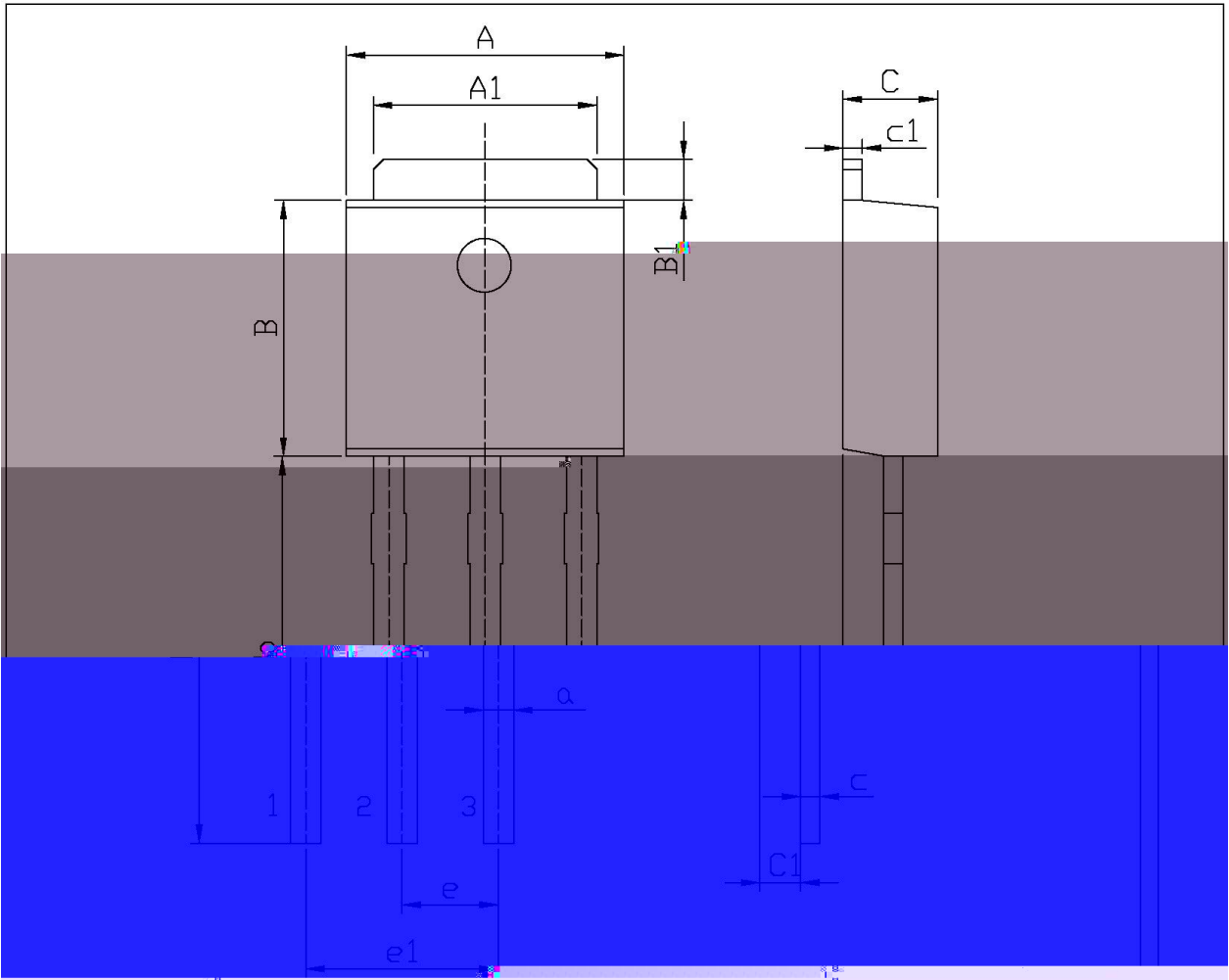
/ Absolute Maximum Ratings(Ta=25)

Parameter	Symbol	Rating	Unit
Drain-Source Voltage	V_{DSS}	500	V
Drain Current	$I_D(T_C=25)$	5	A
Drain Current	$I_D(T_C=100)$	2.8	A
Drain Current - Pulsed	I_{DM}	16	A
Gate-Source Voltage	V_{GSS}	±30	V
Avalanche Current	I_{AR}	4	A
Single Pulsed Avalanche Energy	E_{AS}	300	mJ
Repetitive Avalanche Energy	E_{AR}	4.8	mJ
Power Dissipation ($T_A=25$)	P_D	2.5	W
Power Dissipation ($T_C=25$)	P_D	45	
Junction and Storage Temperature Range	T_{stg}	-55 to 150	

/ Electrical Characteristics(Ta=25)

Parameter	Symbol	Test Conditions	Min	Typ	Max	Unit
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{GS}=0V$ $I_D=250\mu A$	500			V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=500V$ $V_{GS}=0V$			1	μA
		$V_{DS}=400V$ $T_C=125$			10	μA
Gate-Body Leakage Current, Forward	I_{GSS}	$V_{GS}=\pm 30V$ $V_{DS}=0V$			±0.1	μA
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}$ $I_D=250\mu A$	2		4	V
Static Drain-Source On-Resistance	$R_{DS(on)}$	$V_{GS}=10V$ $I_D=2.5A$		1.14	1.4	Ω
Forward Transconductance	g_{FS}	$V_{DS}=40V$ $I_D=2A$		5.2		S
Drain-Source Diode Forward Voltage	V_{SD}	$V_{GS}=0V$ $I_S=5A$			1.4	V
Input Capacitance	C_{iss}	$V_{DS}=25V$ $V_{GS}=0V$ $f=1MHz$		480	625	pF
Output Capacitance	C_{oss}			80	105	
Reverse Transfer Capacitance	C_{rss}			15	20	
Turn-On Delay Time	$t_{d(on)}$	$V_{DD}=250V$ $I_D=5A$ $R_G=25\Omega$		12	35	ns
Turn-On Rise Time	t_r			46	100	
Turn-Off Delay Time	$t_{d(off)}$			50	110	
Turn-Off Fall Time	t_f			48	105	

/ Package Dimensions



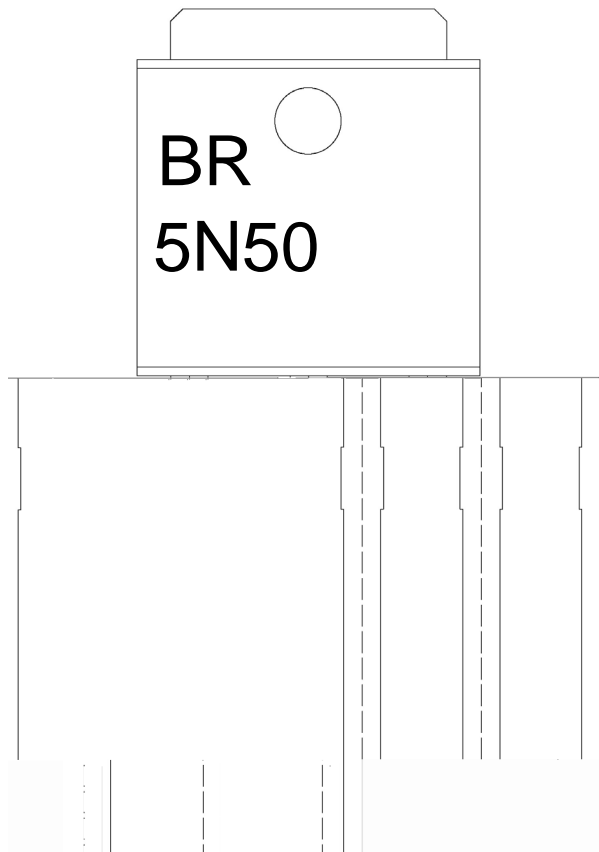
单位: mm

Dimensions In Millimeters | Dimensions In Millimeters

5.10	5.50	b	9.00	9.40	A1
0.95	1.25	c	0.45	0.55	B1
2.20	2.40	c1	2.24	2.34	C
0.95	1.15	e	4.43	4.73	C1
		e1			

TO-251

/ Marking Instructions



BR

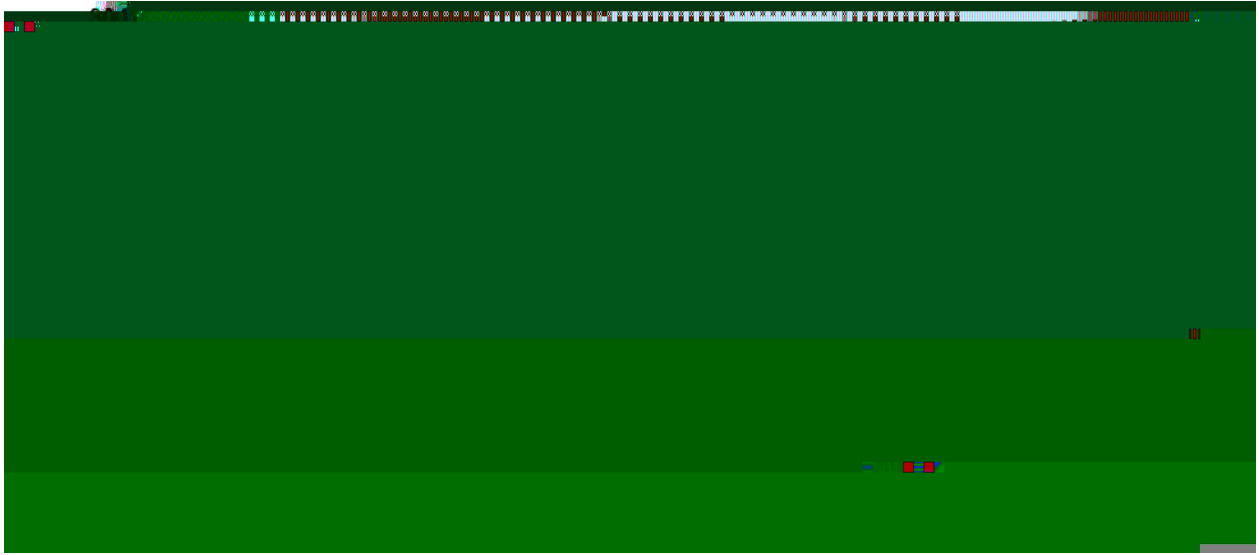
Note:

BR: Company Code

: Product Type.

***: Lot No. Code, code change with Lot No.

() / Temperature Profile for Dip Soldering(Pb-Free)



- | | | | | | | |
|---|-----|-----|----|----------|-------|---|
| 1 | 25 | 150 | 60 | 90sec; | Note: | 1.Preheating:25~150 , Time:60~90sec. |
| 2 | 255 | 5 | 5 | 0.5sec; | | 2.Peak Temp.:255 5 , Duration:5 0.5sec. |
| 3 | | | 2 | 10 /sec. | | 3. Cooling Speed: 2~10 /sec. |

/ Resistance to Soldering Heat Test Conditions

270 5 10 1 sec. Temp.:270±5 Time:10±1 sec

/ Packaging SPEC.

/ BULK

Package Type	Units				Dimension (unit mm ³)		

/ TUBE

Package Type	Units				Dimension (unit mm ³)		

/ Notices